Application No.:

10/536,621

Filing Date:

May 26, 2005

REMARKS

Claims 1, 12, and 20 have been amended by incorporating Claim 8. Further the Claims

have been amended by reciting the material to be polished as an express part of the body of the

claims. Accordingly Claim 8 has been canceled. Support for the amendment of the claims is

present in Claim 8, as previously presented. No new matter has been added. Applicant

respectfully requests entry of the amendments and reconsideration of the present application in

view of the amendments and following remarks.

Rejection on Ground of Nonstatutory Obviousness-type Double Patenting

Claims 1-4, 7, 8, and 10-21 have been provisionally rejected on the ground of nonstatutory

obviousness-type double patenting as being unpatentable over claims 1-24 of copending

Application No. 10/598,717 either alone or in view of secondary references.

A terminal disclaimer in compliance with 37 C.F.R. § 1.321(c) was filed on August

1st 2008, and approved. Applicant acknowledges the approval with appreciation, and request

withdrawal of the rejections.

Claim Rejections – 35 USC §103

Claims 1, 7, and 15 have been rejected under 35 USC §103 as being unpatentable over

Takashi et al. The limitation of Claim 8 has been incorporated into Claim 1. In the Advisory

Action of August 20, 2008, the Examiner interpreted the limitation of Claim 8 as an intended use

as the material being worked by the claimed invention was not recited in the claim. In order to

address this objection, the Claims have been further amended by reciting the material to be

polished as an express part of the body of the claims. Takashi does not disclose the ratio of

length (D) to the diameter of the wafer which is now expressed part of the claim.

Moreover, evaluation results in the specification at Table-3 clearly show the criticality of

the recited ratio of length D to the diameter of wafer as an object of polishing. Examples 6-9,

whose ratios are 0.28, 0.49, 0.28, and 0.28 respectively, show good In-plate uniformity and

Detection of film thickness. In contrast, Comparative Examples 3-5, whose ratios are 0.09, 0.15,

and 0.25 respectively show poor results. Thus, the claimed invention clearly defines a critical

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feature that produces an unexpected advantage. Therefore, Claim 1 as amended herein could

not be rejected on this ground, as well as the dependent Claims 7 and 15. Applicant respectfully

requests withdrawal of this rejection.

Claim Rejections – 35 USC §103

Claims 1 and 7 have been rejected under 35 USC §103 as being unpatentable over

Hasegawa et al. Since Hasegawa does not disclose the ratio of length (D) to the diameter of

wafer as an object of polishing. The same argument as above is applicable here. Applicant

respectfully requests withdrawal of this rejection.

Claim Rejections – 35 USC §103

Claims 2-4 have been rejected under 35 USC §103 as being unpatentable over Toru.

Toru does not disclose the ratio of length (D) to the diameter of the wafer as an object of

polishing, and because of the dependency of the claims, the above amendment on Claim 1

obviates the rejection. Applicant respectfully requests withdrawal of this rejection.

Claim Rejections – 35 USC §103

Claims 14, 16, and 17 have been rejected under 35 USC §103 as being unpatentable over

Toru and Kochiyama. Toru and Kochiyama do not disclose the ratio of length (D) to the

diameter of wafer as an object of polishing, and also because of the dependency of the claims, the

above amendment on Claim 1 obviates the rejection. Applicant respectfully request withdrawal

of this rejection.

Claim Rejections – 35 USC §103

Claims 2-4, 12, and 20 have been rejected under 35 USC §103 as being unpatentable over

Takahashi or Toru. The cited references do not disclose the ratio of length (D) to the diameter

of the wafer as an object of polishing, and also because of the dependency of the claims, the

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above amendment on Claim 1 obviates the rejection on Claims 2-4. Applicant respectfully

request withdrawal of this rejection.

Claims 12 and 20 have been amended in the same manner as Claim 1. Thus, Claims 12

and 20 as amended herein could not be rejected on this ground. Applicant respectfully request

withdrawal of this rejection.

CONCLUSION

In the light of the applicant's amendments to the claims and the following Remarks, it is

respectfully submitted that the present application is in condition for allowance. Should the

Examiner have any remaining concerns which might prevent the prompt allowance of the

application, the Examiner is respectfully invited to contact the undersigned at the telephone

number appearing below.

No Disclaimers or Disavowals

Although the present communication may include alterations to the application or claims,

or characterizations of claim scope or referenced art, the Applicants are not conceding in this

application that previously pending claims are not patentable over the cited references. Rather,

any alterations or characterizations are being made to facilitate expeditious prosecution of this

application. The Applicants reserve the right to pursue at a later date any previously pending or

other broader or narrower claims that capture any subject matter supported by the present

disclosure, including subject matter found to be specifically disclaimed herein or by any prior

prosecution. Accordingly, reviewers of this or any parent, child or related prosecution history

shall not reasonably infer that the Applicants have made any disclaimers or disavowals of any

subject matter supported by the present application.

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Please charge any additional fees, including any fees for additional extension of time, or credit overpayment to Deposit Account No. 11-1410.

Respectfully submitted,

KNOBBE, MARTENS, OLSON & BEAR, LLP

Dated: September 29, 2008

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